## Claims

- 1. A curable composition that forms a continuous phase and a dispersoid at normal temperatures, wherein
- 5 the continuous phase is a liquid at normal temperatures and comprises (a) a compound having two or more epoxy groups in a molecule, and

the dispersoid comprises (b) a compound present as solid particles in a continuous phase at normal temperatures and

- 10 having two or more amino groups in a molecule.
  - 2. The curable composition of claim 1, wherein the compound having two or more amino groups in a molecule is an aromatic amine compound having a benzoxazole structure.

15

- 3. The curable composition of claim 1 or 2, wherein the compound having two or more epoxy groups in a molecule is a liquid at normal temperatures.
- 4. The curable composition of any of claims 1 to 3, wherein the continuous phase contains an organic solvent having a boiling point of not higher than 200°C.
- 5. The curable composition of any of claims 1 to 4, wherein the solid particles have a volume average particle size of  $0.05-50~\mu m$ .